AMENDMENT TRANSMITTAL LETTER (L: Applicant(s): Lloyd Burrell, et al.				atity)		Docket No. FIS920030011US1		
Application No.	Filing Date	Examiner		Customer 1	Vo.	Group Art Unit	Confirmation No.	
10/605,369	0/605,369 9/25/03 MAI, ANH D.			32074		2814	2368	
Invention: SEMICONDUCTOR DEVICE HAVING A COMPOSITE LAYER IN ADDITION TO A BARRIER LAYER BETWEEN COPPER WIRING AND ALUMINUM BOND PAD								
COMMISSIONER FOR PATENTS: Transmitted herewith is an amendment in the above-identified application. The fee has been calculated and is transmitted as shown below.								
CLAIMS AS AMENDED								
	CLAIMS REMAINING	HIGHEST #	NUMBE	R EXTRA			ADDITIONAL	
	AFTER AMENDMENT	PREV. PAID FOR	CLAIMS	PRESENT		RATE	FEE	
TOTAL CLAIMS	12 -	20 =		0 .	x	\$50.00	\$0.00	
INDEP. CLAIMS	2 -	3 =		0	X	\$200.00	\$0.00	
Multiple Dependent Claims (check if applicable)							\$0.00	
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT							\$0.00	
□ Please charge Deposit Account No. in the amount of □ A check in the amount of to cover the filing fee is enclosed. □ The Director is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account 090458 □ □ Any additional filing fees required under 37 C.F.R. 1.16. □ □ Any patent application processing fees under 37 CFR 1.17. □ □ Payment by credit card. Form FTO-2038. WARNING: Information on this form may become public. Credit card Information should not be included on this form. Provide credit card information and authorization on PTO-2038. Dated: □ □ Dated: □ Dated								
cc:				Date of Transmission: 4/905 Name of Person Linda Roberts-Jackson Making Transmission: Signature: Auck Adam - Pub.				